

/ Germany and Other Countries LASER COMPONENTS Germany GmbH Tel +49 8142 2864 - 0 info@lasercomponents.com www.lasercomponents.com / France LASER COMPONENTS S.A.S. Tel +33 1 39 59 52 25 info@lasercomponents.fr www.lasercomponents.fr

/ United Kingdom LASER COMPONENTS (UK) Ltd. Tel +44 1245 491 499 info@lasercomponents.co.uk www.lasercomponents.co.uk







Absolute Maximum Ratings at T₄=23 °C

Parameter	Symbol	Min	Max	Unit			
Voltage	V _R	-	250	V			
Power Dissipation*	-	-	500	mW			
Operating Temperature	T _{op}	-40	+75	°C			
Storage Temperature	T _{stg}	-55	+75	C°			
Package	TO-8						

*Derate linearly to zero at 75°C

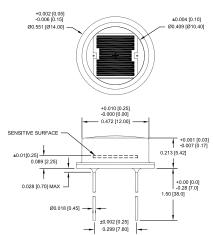
Typical Electro-Optical Specifications at T_A=23 °C

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Light Resistance	2ftc., 2854°K	R	5.5	7.5	10	ΚΩ
	100 ftc.,2854°K	R	-	800	-	Ω
Dark Resistance	5sec after removal of test light	R _D	1.5	-	-	ΜΩ
Spectral Peak	-	λ	-	615	-	nm

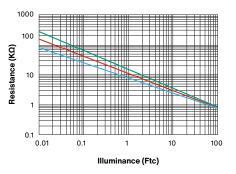
Cells light adapted at 30 to 50 ftc for 16 hrs minimum prior to electrical tests

Mechanical Specifications

Units are in inches [mm]



Resistance vs Illuminance



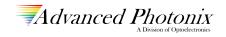
MAX TYP MIN

PASSION FOR PHOTONICS DS NSL-7910 Rev. A

/ Germany and Other Countries LASER COMPONENTS Germany GmbH Tel +49 8142 2864 - 0 info@lasercomponents.com www.lasercomponents.com / France LASER COMPONENTS S.A.S. Tel +33 1 39 59 52 25 info@lasercomponents.fr

/ United Kingdom LASER COMPONENTS (UK) Ltd. Tel +44 1245 491 499 info@lasercomponents.co.uk www.lasercomponents.co.uk







Care and handling instructions

Your optoelectronic components are packaged and shipped in opaque, padded containers to avoid ambient light exposure and damage due to shock from dropping or jarring.

Care must be taken to avoid exposure to high ambient light levels, particularly from tungsten sources or sunlight.

- These components can be rendered inoperable if dropped or sharply jarred. The wire bonds are delicate and can become separated from the bonding pads when the component is dropped or otherwise receives a sharp physical blow.
- Most windows on photodiodes are either silicon or quartz. They should be cleaned with isopropyl alcohol and a soft (optical grade) pad.
- Photodiode exposure to extreme high or low storage temperatures can affect the subsequent performance. Maintain a non-condensing environment for optimum performance and lifetime.
- All devices are considered ESD sensitive. The photodiodes are shipped in ESD protective packaging. When unpacking and using these products, anti-ESD precautions should be observed.
- Photodiode packages and/or operation may be impaired if exposed to CHLOROETHENE, THINNER, ACETONE, TRICHLOROETHYLENE or any harsh chemicals.

Legal Disclaimer

Information in this data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice. Optoelectronic components in plastic packages should be given special care. Clear plastic packages are more sensitive to environmental stress than those of black plastic. Storing devices in high humidity can present problems when soldering. Since the rapid heating during soldering stresses the wire bonds and can cause wire to bonding pad separation, it is recommended that devices in plastic packages to be baked for 24 hours at 85°C.

- The leads on the photodiode SHOULD NOT BE FORMED. If your application requires lead spacing modification, please contact Advanced Photonix Applications group at Techsupport@advancedphotonix.com before forming a product's leads. Product warranties could be voided.
- Most devices are provided with wire or pin leads for installation in circuit boards or sockets. Observe the soldering temperatures and conditions specified below:
- Soldering Iron: Soldering 30 W or less
- Temperature at tip of iron 300°C or lower.
- Dip Soldering: Bath Temperature: 260±5°C.
- Immersion Time: within 5 Sec.
- Soldering Time: within 3 Sec.
- Vapor Phase Soldering, Reflow Soldering: DO NOT USE



PASSION FOR PHOTONICS DS NSL-7910 Rev. A

/ Germany and Other Countries LASER COMPONENTS Germany GmbH Tel +49 8142 2864 - 0 info@lasercomponents.com www.lasercomponents.com / France LASER COMPONENTS S.A.S. Tel +33 1 39 59 52 25 info@lasercomponents.fr www.lasercomponents.fr

/ United Kingdom LASER COMPONENTS (UK) Ltd. Tel +44 1245 491 499 info@lasercomponents.co.uk www.lasercomponents.co.uk